

**General Description**

The CMS4812 uses advanced trench technology to provide excellent RDS(ON).

The two MOSFETs make a compact and efficient switch and synchronous rectifier combination for use in buck converters.

**Features**

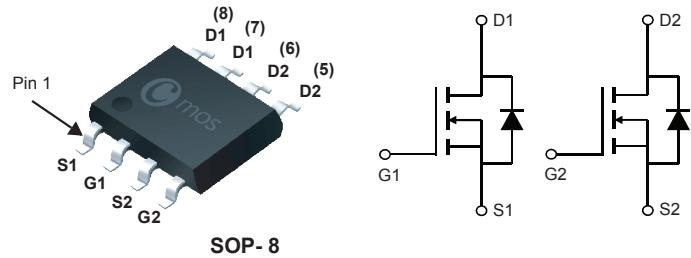
- RDS(ON)≤23mΩ @ VGS=10V
- RDS(ON)≤30mΩ @ VGS=4.5V
- Dual MOSFET in surface mount package.
- High Density Cell Design For Ultra Low On Resistance

**Product Summary**

BVDSS	RDS(ON)	ID
30V	23mΩ	6.9A

**Applications**

- DC/DC Converter
- Load Switch
- Portable Equipment
- Power Management in Note book

**SOP-8 Pin Configuration**

Type	Package	Marking
CMS4812	SOP- 8	4812

**Absolute Maximum Ratings (TA=25°C unless otherwise noted)**

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	30	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub>	Continuous Drain Current	6.9	A
I <sub>DM</sub>	Pulsed Drain Current	21	A
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation	2	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 150	°C

**Thermal Data**

Symbol	Parameter	Typ.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient (Steady-State)	---	110	°C/W

## Dual N-Channel Enhancement Mode MOSFET

Electrical Characteristics ( $T_J=25^\circ\text{C}$  , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$	30	---	---	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}$ , $I_D=6.9\text{A}$	---	---	23	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_D=5\text{A}$	---	---	30	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_D =250\mu\text{A}$	1	---	3	V
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=24\text{V}$ , $V_{\text{GS}}=0\text{V}$	---	---	1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=4.5\text{V}$ , $I_D=6.9\text{A}$	---	7	---	S
$Q_g$	Total Gate Charge	$V_{\text{DS}}=15\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $I_D=6.9\text{A}$	---	13	---	$\text{nC}$
$Q_{\text{gs}}$	Gate-Source Charge		---	1.8	---	
$Q_{\text{gd}}$	Gate-Drain Charge		---	3.2	---	
$T_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DS}}=15\text{V}$ , $V_{\text{GS}} =10\text{V}$ , $R_L=2.2\Omega$	---	6	---	$\text{ns}$
$T_r$	Rise Time		---	4.8	---	
$T_{\text{d(off)}}$	Turn-Off Delay Time		---	28	---	
$T_f$	Fall Time		---	7	---	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=15\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	450	---	$\text{pF}$
$C_{\text{oss}}$	Output Capacitance		---	95	---	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	68	---	

## Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$V_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$ , $I_S=1\text{A}$	---	---	1.1	V

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